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July 10, 2002
Date

Andrew Romero
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of:

Applicant: Dong-Hyuk Ju et al,

Serial No: 09/879,724

Filing Date: June 12, 2001

Art Unit: 2826

Examiner: Ahmed N. Sef

Confirmation No.: 4898

TECHNOLOGY CENTER 2800

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7/27/02

Title: **LEAKY, THERMALLY CONDUCTIVE INSULATOR MATERIAL (LTCIM) IN SEMICONDUCTOR-ON-INSULATOR (SOI) STRUCTURE**

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Commissioner for Patents
U.S. Patent and Trademark Office
Washington, D.C. 20231

REPLY TO OFFICE ACTION DATED APRIL 10, 2002

Dear Sir:

Please amend the above-identified application in the following manner.